

Release Note for AIC HA201 Expander

March 13, 2019

Changelog

03/13/2019 (fw3A6_v1.12.6.1 + mfg3A6.0_HA201_v1.6.0.6) - Part Number (B98-00HA21E0120601 + SEG-0006C006A01)

1. Initial revision

1. SES Pages

- 00h List of supported diagnostic pages
- 01h SES configuration
- 02h SES enclosure control / enclosure status
- 04h SES string out / string in
- 05h SES threshold out / threshold in
- 07h SES element descriptor
- 0Ah SES additional element
- 0Eh SES download microcode control / SES download microcode status
- 80h Vendor specific diagnostic out / diagnostic in
- 81h Vendor specific Bridge I2C out / Bridge I2C in
- 82h Vendor specific chassis number out / chassis number in
- 8Ah Vendor specific Expander PWM out / Expander PWM in

2. Implementation on SES Pages

2.1. SES string out / string in

2.1.1. SES string out

It can be used to control the following items.

Change UUID

- ➤ Change temperature sensor settings on Backplane T1 and T2
- Change two canister status LED
- Change Expander SAS address
- Reset I2C on local Bridge PIC, Backplane PIC, and all Backplane I2C slaves including PMBus
- ➤ Hard reset local Bridge PIC
- Force local Bridge PIC to stay in bootloader mode
- ➤ Hard reset Backplane PIC
- Force Backplane PIC to stay in bootloader mode
- Reset local Expander
- Reset remote Expander
- Configure Backplane PIC setting for Backplane bezel LED state and motherboard power-off mode for the enclosure power button
- Configure Backplane PIC power for powering off and +5V standby power cycling either canister
- Configure an additional blue LED per drive

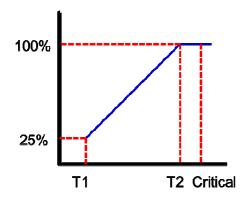
String out format

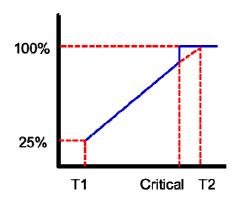
Byte0 ~ Byte7	Change Expander SAS address
	No change – all 0x0
	The change will take effect after expander reset.
Byte8 ~ Byte11	Temperature0 parameters (in Celsius):
	T1, T2, warning threshold, critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
Byte12 ~ Byte15	Temperature1 parameters (in Celsius):
	T1, T2, warning threshold, critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
Byte16 ~ Byte19	Temperature2 parameters (in Celsius):
	T1, T2, warning threshold, critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
Byte20 ~ Byte20	Primary canister status LED – Green
	No change – 0xFF, Not control LED – 0x0, LED on – 0x1,
	LED off – 0x2, LED slow blink – 0x3, LED fast blink – 0x4
	LED slow blink and LED fast blink might look similar due to the scheduling priority

Pyto01 Pyto01	Primary conjeter status IED Red
Byte21 ~ Byte21	Primary canister status LED – Red
	No change – 0xFF, Not control LED – 0x0, LED on – 0x1,
	LED off – 0x2, LED slow blink – 0x3, LED fast blink – 0x4
	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte22 ~ Byte22	Secondary canister status LED – Green
	No change – 0xFF, Not control LED – 0x0, LED on – 0x1,
	LED off – 0x2, LED slow blink – 0x3, LED fast blink – 0x4
	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte23 ~ Byte23	Secondary canister status LED – Red
	No change – 0xFF, Not control LED – 0x0, LED on – 0x1,
	LED off – 0x2, LED slow blink – 0x3, LED fast blink – 0x4
	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte24 ~ Byte39	Change UUID (Byte0 ~ Byte15 on Backplane EEPROM with I2C address: 0xA0)
	No change – all 0x0
Byte40 ~ Byte40	Reset I2C
	No change – 0x0, Reset – 0x1
Byte41 ~ Byte41	Reset Backplane PIC
	No change – 0x0, Reset – 0x1
Byte42 ~ Byte42	Force to stay in Backplane PIC bootloader
	It triggers "Reset I2C" also.
	No change – 0x0, Bootloader – 0x1
Byte43 ~ Byte43	Reset local Bridge PIC
	No change – 0x0, Reset – 0x1
Byte44 ~ Byte44	Force to stay in local Bridge PIC bootloader
	It triggers "Reset I2C" also.
	No change – 0x0, Bootloader – 0x1
Byte45 ~ Byte45	Reset remote Expander
	No change – 0x0, Reset – 0x1
Byte46 ~ Byte46	Reset local Expander
	No change – 0x0, Reset – 0x1
Byte47 ~ Byte47	Configure Backplane PIC setting
	No change – 0xFF
	Power button on force motherboard power-off mode – Bit1 = 0
	Power button on non-force motherboard power-off mode – Bit1 = 1

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Turn on AC loss feature – Bit2 = 0
Turn off AC loss feature – Bit2 = 1
Turn on the bezel power (3.3V and 5V) - Bit5 = 1
Turn off the bezel power (3.3V and 5V) - Bit5 = 0
Configure Backplane PIC power
No change – 0x0
Power off the canister close to the power – Bit7 = 1
Power off the canister away from the power – Bit6 = 1
+5V standby power cycle the canister close to the power – Bit5 = 1
+5V standby power cycle the canister away from the power - Bit4 = 1
+5V standby power cycle duration – Bit3 ~ Bit0 (it ranges between 0.5 second and
8 seconds)
Configure an additional blue LED per drive
No change – Slot ID is invalid
Bit1 ~ Bit0: LED pattern (On: 00, Off: 01, Slow blinking: 10, Fast blinking: 11)
Bit7 ~ Bit2: Slot ID (Slot 0 ~ 23 for an individual slot are valid, and Slot24 for all slots
is valid also)

Smart fan curves for Temperature0, Temperature1, and Temperature2 follow.





2.1.2. SES string in

It can provide status of the following items.

> Expander firmware revision

- Expander manufacture configuration revision
- ► Local Bridge PIC firmware revision
- ➤ Backplane PIC firmware revision
- Backplane UUID
- > Canister slot id
- > Two canister power state in Backplane PIC
- > Two canister power status in Backplane PIC
- > Two canister present status in Backplane PIC
- > Synchronous GPIO status for the other Bridge PIC
- ➤ UART status for the other Bridge PIC
- ➤ Local Bridge PIC data valid indicator
- ➤ Local Bridge PIC healthy state
- ➤ Backplane PIC healthy state
- Backplane PIC setting for Backplane bezel LED state and motherboard power-off mode for the enclosure power button
- Unreadable Backplane I2C slave
- > Temperature sensor settings on Backplane T1 and T2
- > Two canister status LED
- > Expander SAS address
- > Status of the additional blue LED per drive

String in format

Byte0 ~ Byte7	Expander SAS address			
Byte8 ~ Byte11	Expander firmware revision			
Byte12 ~ Byte15	Expander manufacture configuration revision			
Byte16 ~ Byte19	Temperature0 parameters (in Celsius):			
	T1, T2, warning threshold, critical threshold			
	Each parameter is 0xFF while reading failure.			
Byte20 ~ Byte23	Temperature1 parameters (in Celsius):			
	T1, T2, warning threshold, critical threshold			
	Each parameter is 0xFF while reading failure.			
Byte24 ~ Byte27	Temperature2 parameters (in Celsius):			
	T1, T2, warning threshold, critical threshold			
	Each parameter is 0xFF while reading failure.			
Byte28 ~ Byte28	Canister slot id			
	0: primary canister (the right canister or Canister-A)			
	1: secondary canister (the left canister or Canister-B)			
Byte29 ~ Byte29	Local Bridge PIC healthy			

	Healthy – 0x1, Not healthy – 0x0
Byte30 ~ Byte30	Local Bridge PIC data valid indicator
Byteoo Byteoo	Valid – 0x1, Invalid – 0x0
Byte31 ~ Byte31	Backplane PIC setting
bytes i w bytes i	
	Power button on force motherboard power-off mode – Bit1 = 0 (default)
	Power button on non-force motherboard power-off mode – Bit1 = 1
	Turn on AC loss feature – Bit2 = 0
	Turn off AC loss feature – Bit2 = 1 (default)
	Turn on the bezel power (3.3V and 5V) – Bit5 = 1
D. 4-00 D. 4-00	Turn off the bezel power (3.3V and 5V) – Bit5 = 0 (default)
Byte32 ~ Byte32	Unreadable Backplane I2C slave
	Reading failure – 0xFF,
	None – 0x0, Temperature0 – 0x1, Temperature1 – 0x2,
	Temperature2 – 0x3, PCA9555_chip0_port0 – 0x4 or 0x5,
	PCA9555_chip0_port1 - 0x6 or 0x7,
	PCA9555_chip1_port0 – 0x8 or 0x9,
	PCA9555_chip1_port1 - 0xA or 0xB, EEPROM - 0xC,
	Backplane PIC – 0xD, PCA9552_chip_LS0 – 0xE,
	PCA9552_chip_LS1 - 0xF, PCA9552_chip_LS2 - 0x10,
	PCA9552_chip_LS3 - 0x11, PCA9551_chip_LS0 - 0x12,
	PCA9551_chip_LS1 - 0x13
Byte33 ~ Byte33	Sync GPIO healthy
	Reading failure – 0xFF, Healthy – 0x1, Not healthy – 0x0
Byte34 ~ Byte34	UART healthy
	Reading failure – 0xFF, Healthy – 0x1, Not healthy – 0x0
Byte35 ~ Byte35	Backplane PIC healthy
	Reading failure – 0xFF, Healthy – 0x1, Not healthy – 0x0
Byte36 ~ Byte36	Primary canister status LED – Green
	Reading failure – 0xFF
	Bit7 ~ Bit4 for the status:
	LED on – 0x1, LED off – 0x2
	Bit3 ~ Bit0 for the setting:
	Not control LED – 0x0, LED on – 0x1, LED off – 0x2,
	LED slow blink – 0x3, LED fast blink – 0x4

	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte37 ~ Byte37	Primary canister status LED – Red
	Reading failure – 0xFF
	Bit7 ~ Bit4 for the status:
	LED on – 0x1, LED off – 0x2
	Bit3 ~ Bit0 for the setting:
	Not control LED – 0x0, LED on – 0x1, LED off – 0x2,
	LED slow blink – 0x3, LED fast blink – 0x4
	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte38 ~ Byte38	Secondary canister status LED – Green
	Reading failure – 0xFF
	Bit7 ~ Bit4 for the status:
	LED on – 0x1, LED off – 0x2
	Bit3 ~ Bit0 for the setting:
	Not control LED – 0x0, LED on – 0x1, LED off – 0x2,
	LED slow blink – 0x3, LED fast blink – 0x4
	225 SIGN SIMIN SAC, 225 Iddi Simin SAT
	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte39 ~ Byte39	Secondary canister status LED – Red
	Reading failure – 0xFF
	Bit7 ~ Bit4 for the status:
	LED on – 0x1, LED off – 0x2
	Bit3 ~ Bit0 for the setting:
	Not control LED – 0x0, LED on – 0x1, LED off – 0x2,
	LED slow blink – 0x3, LED fast blink – 0x4
	LED slow blink and LED fast blink might look similar due to the scheduling priority
Byte40 ~ Byte40	Primary canister present status
	Reading failure – 0xFF, Not present – 0x0, Present – 0x1
Byte41 ~ Byte41	Secondary canister present status
	Reading failure – 0xFF, Not present – 0x0, Present – 0x1

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Byte42 ~ Byte42	Primary canister power status
District 10	Reading failure – 0xFF, Power off – 0x0, Power on – 0x1
Byte43 ~ Byte43	Secondary canister power status
	Reading failure – 0xFF, Power off – 0x0, Power on – 0x1
Byte44 ~ Byte44	Primary canister power state
	Reading failure – 0xFF, Clean state – 0x0
	Canister not present – 0x1, Canister present and off – 0x2
	Canister present and on – 0x3
	Canister present but failed to power on – 0x4
Byte45 ~ Byte45	Secondary canister power state
	Reading failure – 0xFF, Clean state – 0x0
	Canister not present – 0x1, Canister present and off – 0x2
	Canister present and on – 0x3
	Canister present but failed to power on – 0x4
Byte46 ~ Byte61	Backplane UUID (Byte0 ~ Byte15 on Backplane EEPROM with I2C address: 0xA0)
Byte62 ~ Byte63	Reserved
Byte64 ~ Byte66	Backplane PIC firmware revision
Byte67 ~ Byte69	Bridge PIC firmware revision
Byte70 ~ Byte70	Additional blue LED
	Bit1 ~ Bit0: Slot 0
	Bit3 ~ Bit2: Slot 1
	Bit5 ~ Bit4: Slot 2
	Bit7 ~ Bit6: Slot 3
	LED on: 00, LED off: 01, LED slow blinking: 10, LED fast blinking: 11
Byte71 ~ Byte71	Additional blue LED
	Bit1 ~ Bit0: Slot 4
	Bit3 ~ Bit2: Slot 5
	Bit5 ~ Bit4: Slot 6
	Bit7 ~ Bit6: Slot 7
	LED on: 00, LED off: 01, LED slow blinking: 10, LED fast blinking: 11
Byte72 ~ Byte72	Additional blue LED
	Bit1 ~ Bit0: Slot 8
	Bit3 ~ Bit2: Slot 9
	Bit5 ~ Bit4: Slot 10
	Bit7 ~ Bit6: Slot 11

	LED on: 00, LED off: 01, LED slow blinking: 10, LED fast blinking: 11			
Byte73 ~ Byte73	Additional blue LED			
	Bit1 ~ Bit0: Slot 12			
	Bit3 ~ Bit2: Slot 13			
	Bit5 ~ Bit4: Slot 14			
	Bit7 ~ Bit6: Slot 15			
	LED on: 00, LED off: 01, LED slow blinking: 10, LED fast blinking: 11			
Byte74 ~ Byte74	Additional blue LED			
	Bit1 ~ Bit0: Slot 16			
	Bit3 ~ Bit2: Slot 17			
	Bit5 ~ Bit4: Slot 18			
	Bit7 ~ Bit6: Slot 19			
	LED on: 00, LED off: 01, LED slow blinking: 10, LED fast blinking: 11			
Byte75 ~ Byte75	Additional blue LED			
	Bit1 ~ Bit0: Slot 20			
	Bit3 ~ Bit2: Slot 21			
	Bit5 ~ Bit4: Slot 22			
	Bit7 ~ Bit6: Slot 23			
	LED on: 00, LED off: 01, LED slow blinking: 10, LED fast blinking: 11			

2.2. SES threshold out / threshold in

It includes only Temperature Sensor and Cooling elements.

Threshold control element format

BYTE/BIT	7	6	5	4	3	2	1	0
0	REQUESTED HIGH CRITICAL THRESHOLD							
1		REQUESTED HIGH WARNING THRESHOLD						
2		REQUESTED LOW WARNING THRESHOLD						
3	REQUESTED LOW CRITICAL THRESHOLD							

Threshold status element format

BYTE/BIT	7	6	5	4	3	2	1	0
0			HI	GH CRITICA	L THRESHO	LD		

1	HIGH WARNING THRESHOLD
2	LOW WARNING THRESHOLD
3	LOW CRITICAL THRESHOLD

2.3. Vendor specific diagnostic out / diagnostic in

2.3.1. Vendor specific out / vendor specific in for I2C access on Backplane

It supports the following commands. Each "Send I2C access command" should be followed by a "Get I2C result". While issuing another "Send I2C access command" after sending a "Send I2C access command", you would get error reported. After sending a "Send I2C access command", a "Cancel I2C access command" should be issued before sending another "Send I2C access command".

- (A) Send I2C access command (the vendor specific out)
- (B) Get I2C result (the vendor specific in)
- (C) Cancel I2C access command (the vendor specific out)

There are two Vendor specific in formats and two Vendor specific out formats.

Vendor specific in format-1

Byte0 ~ Byte0	Return code for success – 0x0		
Byte1 ~ Byte1	ead length in bytes		
Byte(1+1)~Byte(1+1)	ead data-1		
Byte(1+N)~Byte(1+N)	read data-N		
	N can be up to 128		

Vendor specific in format-2

Byte0 ~ Byte0	Return code for failure
	local Bridge PIC failed to read from/write to the target device via I2C - 0x1
	local Bridge PIC memory allocation failure – 0x2
	Invalid data from local Bridge PIC – 0x3
	Expander failed to read from local Bridge PIC via I2C excluding data timeout – 0x4
	Expander memory allocation failure – 0x5
	No I2C read command sent – 0x6
	Data timeout from local Bridge PIC – 0x7

Vendor specific out format-1

Byte0 ~ Byte0	Send I2C access command – 0x0
Byte1 ~ Byte1	I2C slave address

Byte2 ~ Byte2	read length in bytes
Byte3 ~ Byte3	write length in bytes
Byte(3+1)~Byte(3+1)	write data-1
Byte(3+N)~Byte(3+N)	write data-N
	N can be up to 128

Vendor specific out format-2

Byte0 ~ Byte0 Cancel I2C access command – 0x1		
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Example:

Take PMBus for example. The I2C address of the PMBus power module is 0xB2. We try to read the input voltage of the power module. In the specification of the power module, the input voltage is output with a 2-byte format after being written one command byte "0x88" via I2C. The following data (read length = 2 and write length = 1) will be sent via the vendor specific out page.

00 B2 02 01 88

After the vendor specific out page, you can issue the vendor specific in page to get the following data. It's a successful command (0x00), length of data (0x02), and the output data (0x63 and 0xeb).

00 02 63 eb

2.3.2. I2C error / reset statistic

It supports up to 128-byte reading data for I2C error statistic and I2C interface reset count. Each I2C error count consists of 2 consecutive bytes repositioned for Little-endian machines (the low byte first, then the high byte).

Vendor specific in format-1

Byte0 ~ Byte0	Return code for success – 0x0
Byte1 ~ Byte1	0x80
Byte(1+1)~Byte(1+1)	read data-1
Byte(1+N)~Byte(1+N)	read data-N
	N is 128

The 5 error counts (writeI2C, readI2C, dataFormat, dataComparison, and

dataTimeout monitored by Expander) consist of the first 10 bytes. The 5 error counts monitored by Expander are described below.

(A) writeI2C: Fail to write I2C

(B) readI2C: Fail to read I2C

(C) dataFormat: Data format read from local Bridge PIC is incorrect

(D) dataComparison: Read local Bridge PIC twice, and compare both data

(E) dataTimeout: Data timeout from local Bridge PIC

The following 110 bytes monitored by Bridge PIC are divided by 11 groups (10 bytes each group). The 5 error counts (BusArbitration, MasterHardware, SlaveResponse, MemoryAllocation, and DataComparison) consist of each 10-byte group. The 11 groups are listed below in order.

Group 1: Backplane temperature sensor 0

Group 2: Backplane temperature sensor 1

Group 3: Backplane temperature sensor 2

Group 4: Backplane PCA9555-0

Group 5: Backplane PCA9555-1

Group 6: Backplane EEPROM

Group 7: Backplane PIC

Group 8: Backplane PMBus

Group 9: IPMB (from Bridge PIC I2C master to Motherboard IPMB I2C slave)

Group 10: Backplane PCA9552 Group 11: Backplane PCA9551

The 5 error counts monitored by Bridge PIC are described below.

- (A) BusArbitration: It's nothing to do with the sync GPIO. The error is raised while Bridge PIC fails to start I2C sequence due to the I2C bus signal.
- (B) MasterHardware: Error for the I2C master interface like the abnormal interface status after starting I2C sequence, interface transmitter never ready, ...
- (C) SlaveResponse: Can't get proper response from the I2C slave
- (D) MemoryAllocation: Bridge PIC fails to allocate memory for processing I2C access
- (E) DataComparison: Read the same I2C slave device twice, and compare both data

The last 8 bytes monitored by Bridge PIC are 4 interface reset counts (I2C master for Backplane, I2C slave for Expander, I2C master for local IPMB, and I2C slave for

remote IPMB).

Vendor specific out format-1

Byte0 ~ Byte0	Send I2C access command – 0x0
Byte1 ~ Byte1	0x0
Byte2 ~ Byte2	0x80
Byte3 ~ Byte3	0x0

Example:

To read I2C error statistic and I2C interface reset count, issue the vendor specific out page with the following data.

00 00 80 00

After the vendor specific out page, you can issue the vendor specific in page to get the following data. It's a successful command (0x00), 128 data bytes (0x80), and the output data.

00 80 00 00 00 00 00 00	00 00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00 00 00 00 00 00 00	00 00 00 00 00 00 00 00
00 00	

2.4. Vendor specific Bridge I2C out / Bridge I2C in

It supports the following commands. Each "Send I2C access command" should be followed by a "Get I2C result". While issuing another "Send I2C access command" after sending a "Send I2C access command", you would get error reported. After sending a "Send I2C access command", a "Cancel I2C access command" should be issued before sending another "Send I2C access command".

- (A) Send I2C access command (the vendor specific out)
- (B) Get I2C result (the vendor specific in)
- (C) Cancel I2C access command (the vendor specific out)

There are two Vendor specific in formats and two Vendor specific out formats.

Vendor specific in format-1

Byte0 ~ Byte0	Return code for success – 0x0
Byte1 ~ Byte1	read length in bytes
Byte(1+1)~Byte(1+1)	read data-1
Byte(1+N)~Byte(1+N)	read data-N
	N can be up to 32

Vendor specific in format-2

Byte0 ~ Byte0	Return code for failure
	Expander failed to access Bridge I2C slave – 0x4
	Expander memory allocation failure – 0x5
	No I2C read command sent – 0x6

Vendor specific out format-1

Byte0 ~ Byte0	Send I2C access command – 0x0
Byte1 ~ Byte1	I2C slave address
Byte2 ~ Byte2	read length in bytes
Byte3 ~ Byte3	write length in bytes
Byte(3+1)~Byte(3+1)	write data-1
Byte(3+N)~Byte(3+N)	write data-N
	N can be up to 34

Vendor specific out format-2

Byte0 ~ Byte0	Cancel I2C access command – 0x1
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Example:

Take Bridge EEPROM for example. The I2C address of Bridge EEPROM is 0xA0. We try to read 32 bytes from the address 0x0020 which is 2 bytes in Bridge EEPROM specification. The following data (read length = 4 and write length = 2) will be sent via the vendor specific out page.

00 A0 04 02 00 20

After the vendor specific out page, you can issue the vendor specific in page to get the following data. It's a successful command (0x00), length of data (0x04), and the 4-bytes output data.

00 04 30 31 32 33

2.5. Vendor specific chassis number out / chassis number in

The chassis number is kept on Byte256 ~ Byte511 of the EEPROM on the chassis backplane. The I2C address of the backplane EEPROM is 0xA0. The length of the chassis number is not more than 247 bytes.

The chassis number is the unit serial number in the VPD (Vital Product Data) page fetched with a SCSI INQUIRY command.

2.5.1. Vendor specific chassis number out

In order to update the chassis number on the backplane EEPROM, the length of the chassis number must be $1 \sim 247$ bytes. To invalidate the chassis number, the length should be applied with 0.

Chassis number (0 ~ 247 bytes)

2.5.2. Vendor specific chassis number in

Byte0 ~ Byte0	Valid data: 0x0, invalid data: 0x1
Chassis number or none	Chassis number (1 ~ 247 bytes) for valid data, none for invalid data

2.6. Vendor specific Expander PWM out / Expander PWM in

2.6.1. Vendor specific Expander PWM out

It can be used to control the following items.

- Enable/disable Motherboard temperature reading for Bridge PIC's fan control
- ➤ Change CPU0 thermal margin settings T1, T2, T3, and T4
- ➤ Change CPU1 thermal margin settings T1, T2, T3, and T4
- ➤ Change DIMM thermal margin settings T1, T2, T3, and T4
- ➤ Change local or remote PWM output manually (%)
- ➤ Change Expander on-die temperature settings T1, T2, T3, and T4

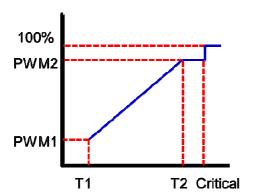
Expander PWM out format

Byte0 ~ Byte0	Enable/disable Motherboard temperature reading for Bridge PIC's fan control
	No change – other than 0x0 and 0x1

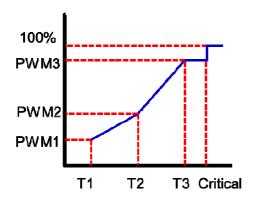
	Enable – 0x1
	Disable – 0x0
D D	
Byte1 ~ Byte10	CPU0 thermal margin parameters (in Celsius):
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,
	critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
Byte11 ~ Byte20	CPU1 thermal margin parameters (in Celsius):
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,
	critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
Byte21 ~ Byte30	DIMM thermal margin parameters (in Celsius) shared by all DIMMs:
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,
	critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
Byte31 ~ Byte31	Change local or remote PWM output manually (%)
	No change – 0xFF
	Local PWM control – Bit7 = 0
	Remote PWM control – Bit7 = 1
	Manual PWM output (%) – Bit6 ~ Bit0 (invalid if its value is more than 100)
Byte32 ~ Byte41	Expander on-die temperature parameters (in Celsius):
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,
	critical threshold
	No change – all 0x0
	The change will take effect after expander reset.
	,

Smart fan curves below for expander and motherboard sensors are supported.

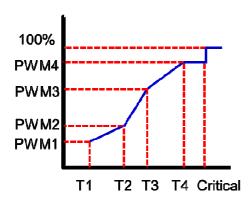
(1) Use T1, T2, PWM1 (%), and PWM2 (%) for the curve. The other settings include T3=0, T4=0, PWM3=0, and PWM4=0.



(2) Use T1, T2, T3, PWM1 (%), PWM2 (%), and PWM3 (%) for the curve. The other settings include T4=0 and PWM4=0.



(3) Use T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), and PWM4 (%) for the curve.



2.6.2. Vendor specific Expander PWM in

It can provide status of the following items.

> Setting of Motherboard temperature reading for Bridge PIC's fan control

- > Unsuccessful read count for CPU0, CPU1, and DIMM
- > CPU0/CPU1/DIMM thermal margin reading and its status
- > CPU0 thermal margin settings T1, T2, T3, and T4
- ➤ CPU1 thermal margin settings T1, T2, T3, and T4
- > DIMM thermal margin settings T1, T2, T3, and T4
- ➤ Current local PWM output (%)
- Expander on-die temperature settings T1, T2, T3, and T4

Expander PWM in format

Byte0 ~ Byte0	Setting of Motherboard temperature reading for Bridge PIC's fan control
	Reading failure – 0xFF
	Enable – 0x1
	Disable - 0x0
Byte1 ~ Byte1	Unsuccessful read count for CPU0, CPU1, and DIMM
	Reading failure – 0xFF
	Reported range: 0x0 ~ 0x64
	If 0x64 is reported, the fan runs at full speed when Motherboard temperature
	reading for Bridge PIC's fan control is enabled.
Byte2 ~ Byte2	CPU0 thermal margin reading
Byte3 ~ Byte3	Status of CPU0 thermal margin reading
	No successful reading – 0xFF
	All BMC Event Messages disabled from this sensor – Bit7 = 0
	Sensor scanning disabled – Bit6 = 0
	Reading/state unavailable – Bit5 = 1
Byte4 ~ Byte4	CPU1 thermal margin reading
Byte5 ~ Byte5	Status of CPU1 thermal margin reading
	No successful reading – 0xFF
	All BMC Event Messages disabled from this sensor – Bit7 = 0
	Sensor scanning disabled – Bit6 = 0
	Reading/state unavailable – Bit5 = 1
Byte6 ~ Byte6	DIMM1 thermal margin reading
Byte7 ~ Byte7	Status of DIMM1 thermal margin reading
	No successful reading – 0xFF
	All BMC Event Messages disabled from this sensor – Bit7 = 0

	Sensor scanning disabled – Bit6 = 0		
	Reading/state unavailable – Bit5 = 1		
Byte8 ~ Byte8	DIMM2 thermal margin reading		
Byte9 ~ Byte9	Status of DIMM2 thermal margin reading		
	No successful reading – 0xFF		
	All BMC Event Messages disabled from this sensor – Bit7 = 0		
	Sensor scanning disabled – Bit6 = 0		
	Reading/state unavailable – Bit5 = 1		
Byte10 ~ Byte10	DIMM3 thermal margin reading		
Byte11 ~ Byte11	Status of DIMM3 thermal margin reading		
	No successful reading – 0xFF		
	All BMC Event Messages disabled from this sensor – Bit7 = 0		
	Sensor scanning disabled – Bit6 = 0		
	Reading/state unavailable – Bit5 = 1		
Byte12 ~ Byte12	DIMM4 thermal margin reading		
Byte13 ~ Byte13	Status of DIMM3 thermal margin reading		
	No successful reading – 0xFF		
	All BMC Event Messages disabled from this sensor – Bit7 = 0		
	Sensor scanning disabled – Bit6 = 0		
	Reading/state unavailable – Bit5 = 1		
Byte14 ~ Byte23	CPU0 thermal margin parameters (in Celsius):		
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,		
	critical threshold		
Byte24 ~ Byte33	CPU1 thermal margin parameters (in Celsius):		
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,		
	critical threshold		
Byte34 ~ Byte43	DIMM thermal margin parameters (in Celsius) shared by all DIMMs:		
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,		
	critical threshold		
Byte44 ~ Byte44	Current local PWM output (%)		
	Reading failure – 0xFF		
Byte45 ~ Byte54	Expander on-die temperature parameters (in Celsius):		
	T1, T2, T3, T4, PWM1 (%), PWM2 (%), PWM3 (%), PWM4 (%), warning threshold,		
	critical threshold		

2.7. Bezel I2C access through Backplane PIC

Use Vendor specific diagnostic in/diagnostic out formats to access Backplane PIC (0x30), and follow the formats below to access Bezel I2C. Please follow three steps below.

(1) Issue a Bezel I2C access command with the following format which supports I2C read command with up to 16 bytes, I2C write command with up to 16 bytes, and I2C write-read command with up to 16 bytes for read and 8 bytes for write.

Bezel I2C access command format

Backplane PIC address	Description	
0x80	I2C command state	
	If the "0xFF" (busy on processing the command) is reported, this field is not	
	changeable.	
	Command trigger – 0x0	
0x81	I2C channel	
	The channels supported are 0x3 and 0x4.	
0x82	Bezel I2C 7-bit slave address	
0x83	Read bytes (up to 16 bytes)	
0x84	Write bytes	
	Up to 16 bytes for I2C write command, and up to 8 bytes for I2C write-read	
	command.	
0x85 ~ 0x94	Write Data	

(2) Get the status of the Bezel I2C access command issued.

Bezel I2C command status format

Backplane PIC address	Description
0x80	I2C command state
	Status reported:
	Format error – 0x33
	Successful – 0x55
	Error on processing the command – 0xAA
	I2C bus error – 0xCC

(3) Get the read data for I2C read command and I2C write-read command.

Bezel I2C read data format

Backplane PIC address	Description
0xA0 ~ 0xAF	Read Data

3. SES Elements

• 02h - Power Supply

Number of possible elements: 2

- 03h Cooling (it is not supported while the number of elements is 0) Number of possible elements: 0, 4, or 8 (it depends on the jumper setting of Bridge board)
- 04h Temperature Sensor

Number of possible elements: 4

• 0Eh - Enclosure

Number of possible elements: 1

• 17h - Array Device

Number of possible elements: 24

4. Implementation on SES Elements

Only the fields highlighted in green are supported.

4.1. Power Supply Element

4.1.1. Power Supply Control Element

BYTE/BIT	7	7 6		4	3	2	1	0
0	COMMON CONTROL							
	SELECT	PRDFAIL DISABLE RST SWAP Reserved						
1	RQST IDENT	Reserved						
2		Reserved						
3	Reserved	RQST FAIL RQST ON Reserved						

4.1.2. Power Supply Status Element

BYTE/BIT	7	6	5	4	3	2	1	0
0				COMN	ION STATUS			
	Reserved	PRDFAIL DISABLED SWAP ELEMENT STATUS CODE						
1	IDENT	Reserved						
2		Reserved			DC OVER	DC UNDER	DC OVER	Reserved
		VOLTAGE VOLTAGE CURRENT						
3	НОТ	FAIL	RQSTED	OFF	OVERTMP	TEMP	AC FAIL	DC FAIL
	SWAP		ON		FAIL	WARN		

Field	Value
	OK: No failure or warning conditions detected
ELEMENT STATUS CODE	CRITICAL: FAIL bit is set due to one or more failure condition
	UNKNOWN: Can't get information from Bridge MCU
FAIL	A failure condition is detected
AC FAIL	A failure condition is detected
DC FAIL	A failure condition is detected

4.2. Cooling Element

4.2.1. Cooling Control Element

BYTE/BIT	7	6	5	4	3	3 2 1 0					
0			COMMON CONTROL								
	SELECT	PRDFAIL	DISABLE	RST SWAP	Reserved						
1	RQST IDENT			Re	eserved						
2				Reserved							
3	Reserved	RQST FAIL	RQST ON	Reser	rved REQUESTED SPEED CODE						

Field	Value
RQST IDENT	Please refer to section "SES Element Control Functions" for
TIQOT IDENT	details.
	Please refer to section "SES Element Control Functions" for
REQUESTED SPEED CODE	details.

4.2.2. Cooling Status Element

BYTE/BIT	7	6	5	4	3	2	1	0			
0		COMMON STATUS									
	Reserved	PRDFAIL	DISABLED	SWAP	ELEMENT STATUS CODE						
1	IDENT		Reserv	ed		ACTUAL	FAN SPEE	D (MSB)			
2			ACT	UAL FAN SPI	EED (LSB)						
3	HOT SWAP	FAIL	RQSTED ON	OFF	Reserved ACTUAL SPEED CODE						

Field	Value				
	OK: Everything is Ok				
ELEMENT STATUS CODE	NON-CRITICAL: If either warning limit is exceeded				
ELEMENT STATUS CODE	CRITICAL: If either failure limit is exceeded				
	UNKNOWN: Can't get information from Bridge MCU				
	Applicable only for Cooling element 0 and Cooling element 4				
IDENT	0: Enable the smart fan function				
	1: Disable the smart fan function				
ACTUAL FAN SPEED	Current fan RPM				
FAIL	The fan RPM can't be detected or equal to 0				
	000b: Stopped. Current RPM = 0				
	001b: Lowest speed. 0 $<$ Current RPM \leq 5000				
	010b: Second lowest speed. 5000 $<$ Current RPM \leq 7000				
	011b: Third lowest speed. 7000 $<$ Current RPM \leq 9000				
ACTUAL SPEED CODE	100b: Intermediate speed. 9000 $<$ Current RPM \leq 11000				
	101b: Third highest speed. 11000 $<$ Current RPM \leq 13000				
	110b: Second highest speed. 13000 $<$ Current RPM \leq				
	15000				
	111b: Highest speed. 15000 < Current RPM				

4.3. Temperature Sensor Element

4.3.1. Temperature Sensor Control Element

BYTE/BIT	7	6	5	4	3	2	1	0			
0		COMMON CONTROL									
	SELECT	PRDFAIL	DISABLE	DISABLE RST SWAP Reserved							
1	RQST IDENT	RQST FAIL			Reserv	ed					
2		Reserved									
3				Reserved							

4.3.1. Temperature Sensor Status Element

BYTE/BIT	7	6	5	4	3	2	1	0			
0		COMMON STATUS									
	Reserved	PRDFAIL	DISABLED	DISABLED SWAP ELEMENT STATUS CODE							
1	IDENT	FAIL			R	eserved					
2				TEMF	PERATURE						
3		Pos	erved		ОТ	ОТ	UT	UT WARNING			
3		nesi	erveu		FAILURE	WARNING	FAILURE				

Field	Value
	OK: Everything is Ok
ELEMENT STATUS CODE	NON-CRITICAL: If either warning limit is exceeded
ELEMENT STATUS CODE	CRITICAL: If either failure limit is exceeded
	UNKNOWN: Can't get information from Bridge MCU
FAIL	A warning or failure condition is detected
TEMPERATURE	Temperature reading
OT FAILURE	Temperature has exceeded the failure high threshold value
OT WARNING	Temperature has exceeded the warning high threshold value
UT FAILURE	Temperature is below the failure low threshold value
UT WARNING	Temperature is below the warning low threshold value

4.4. Enclosure Element

4.4.1. Enclosure Control Element

BYTE/BIT	7	6	5	4	3	2	1	0		
0		COMMON CONTROL								
	SELECT	PRDFAIL	DISABLE	RST SWAP			Reserved			
1	RQST IDENT				Reserved					
2	POWER CYCL	E REQUEST			POWER C	YCLE DEI	LAY			
3		POWER OFF DURATION REQUEST REC						REQUEST		
							FAILURE	WARNING		

4.4.2. Enclosure Status Element

BYTE/BIT	7	6	5	4	3	2	1	0
D. I.E/DII	•	_		-		_	•	Ū

0	COMMON STATUS									
	Reserved	PRDFAIL DISABLED SWAP ELEMENT STATUS CODE								
1	IDENT	Reserved								
2		TIM	E UNTIL POWE	R CYCLE		FAILURE	WARNING			
						INDICATION	INDICATION			
3		REQUE	FAILURE	WARNING						
3						REQUESTED	REQUESTED			

Field	Value
ELEMENT STATUS CODE	OK

4.5. Array Device Element

4.5.1. Array Device Control Element

BYTE/BIT	7	6	5	4	3	2	1	0				
0		COMMON CONTROL										
	SELECT	PRDFAIL	DISABLE	RST SWAP		Reser	ved					
1	RQST	RQST RSVD	RQST HOT	RQST CONS	RQST IN	RQST IN FAILED	RQST REBULD/	RQST R/R				
	ок	DEVICE	SPARE	CHECK	CRIT ARRAY	ARRAY	REMAP	ABORT				
2	RQST	DO NOT	Reserved	RQST	RQST	RQST REMOVE	RQST IDENT	Reserved				
	ACTIVE	REMOVE	neserved	MISSING	INSERT	NQ31 NEMOVE	NQ31 IDEN1					
3	Reserved		RQST		ENABLE BYP	ENABLE BYP B	Decembed					
	n.	zsei veu	FAULT	FAULT DEVICE OFF		LIVABLE DIF D	Reserved					

Field	Value
PRDFAIL	Please refer to section "SES Element Control Functions" for
FROTAIL	details.
RQST OK	Please refer to section "SES Element Control Functions" for
ngsi ok	details.
ROST RSVD DEVICE	Please refer to section "SES Element Control Functions" for
NGST NSVD DEVICE	details.
ROST HOT SPARE	Please refer to section "SES Element Control Functions" for
NQST HOT SPANE	details.
ROST CONS CHECK	Please refer to section "SES Element Control Functions" for
NGST CONS CHECK	details.
RQST IN CRIT ARRAY	Please refer to section "SES Element Control Functions" for
ngo in onii annat	details.

Please refer to section "SES Element Control Functions" for details. RQST REBUILD/REMAP Please refer to section "SES Element Control Functions" for details. RQST R/R ABORT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. RQST MISSING Please refer to section "SES Element Control Functions" for details. RQST INSERT Please refer to section "SES Element Control Functions" for details. RQST REMOVE Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.		
ROST REBUILD/REMAP Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	ROST IN FAILED ARRAY	Please refer to section "SES Element Control Functions" for
RQST REBUILD/REMAP details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. RQST MISSING Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. RQST INSERT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.		details.
RQST R/R ABORT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	ROST RERUII D/REMAP	Please refer to section "SES Element Control Functions" for
RQST R/R ABORT details. Please refer to section "SES Element Control Functions" for details. DO NOT REMOVE Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	TIGOT TIEDOIED/TIEIVIAI	details.
DO NOT REMOVE Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DOST D/D ARODT	Please refer to section "SES Element Control Functions" for
RQST ACTIVE details. Please refer to section "SES Element Control Functions" for details. RQST MISSING Please refer to section "SES Element Control Functions" for details. RQST INSERT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. RQST IDENT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	ngoi n/n adoni	details.
DO NOT REMOVE Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DOST ACTIVE	Please refer to section "SES Element Control Functions" for
DO NOT REMOVE details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	RQSTACTIVE	details.
RQST MISSING Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DO NOT DEMOVE	Please refer to section "SES Element Control Functions" for
RQST MISSING details. Please refer to section "SES Element Control Functions" for details. RQST REMOVE Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DO NOT REMOVE	details.
details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DOST MISSING	Please refer to section "SES Element Control Functions" for
RQST INSERT details. Please refer to section "SES Element Control Functions" for details. RQST IDENT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	ngor wissing	details.
RQST REMOVE Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DOST INSERT	Please refer to section "SES Element Control Functions" for
RQST REMOVE details. Please refer to section "SES Element Control Functions" for details. RQST FAULT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	ngoi ingeni	details.
RQST IDENT Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details. Please refer to section "SES Element Control Functions" for details.	DOST DEMOVE	Please refer to section "SES Element Control Functions" for
RQST IDENT details. Please refer to section "SES Element Control Functions" for details. DEVICE OFF DEVICE OFF	NQ31 NEIVIOVE	details.
details. Please refer to section "SES Element Control Functions" for details. DEVICE OFF DEVICE OFF	DOST IDENT	Please refer to section "SES Element Control Functions" for
RQST FAULT details. Please refer to section "SES Element Control Functions" for	NGO I IDENI	details.
DEVICE OFF details. Please refer to section "SES Element Control Functions" for	DOST FALILT	Please refer to section "SES Element Control Functions" for
DEVICE OFF	TIGOT FAULT	details.
	DEVICE OFF	Please refer to section "SES Element Control Functions" for
	DEVICE OFF	details.

4.5.2. Array Device Status Element

BYTE/BIT	7	6	5	4	3	2	1	0		
0		COMMON STATUS								
	Reserved	PRDFAIL	DISABLED	SWAP		ELEMENT	STATUS CODE			
1	OK	RSVD	HOT SPARE	CONS CHK	IN CRIT	IN FAILED	REBUILD/	R/R ABORT		
	ÜK	DEVICE	HOT SPANE	HOT SPARE CONSIGNA		ARRAY	REMAP	n/n Abon i		
2	APP CLIENT	DO NOT	ENCLOSURE	ENCLOSURE	READY TO	RMV	IDENT	REPORT		
	BYPASSED A	REMOVE	BYPASSED A	BYPASSED B	INSERT	LIVIV	IDENT	NEFONI		
3	APP CLIENT	FAULT	FAULT	DEVICE OFF	BYPASSED	BYPASSED	DEVICE	DEVICE		
3	BYPASSED B	SENSED	REQSTD	DEVICE OFF	Α	В	BYPASSED A	BYPASSED B		

Field	Value
PRDFAIL	Set by the PRDFAIL on Array Device Control Element

	<u></u>		
ELEMENT STATUS CODE	OK: A drive is detected in the slot		
ELEMENT STATOS CODE	NOT INSTALLED: No drive is installed in the slot		
OK	Set by the RQST OK on Array Device Control Element		
RSVD DEVICE	Set by the RQST RSVD DEVICE on Array Device Control		
RSVD DEVICE	Element		
HOT SPARE	Set by the RQST HOT SPARE on Array Device Control		
HOI SPARE	Element		
CONS CHK	Set by the RQST CONS CHECK on Array Device Control		
CONSIGN	Element		
IN CRIT ARRAY	Set by the RQST IN CRIT ARRAY on Array Device Control		
IN CRIT ARRAY	Element		
IN FAILED ARRAY	Set by the RQST IN FAILED ARRAY on Array Device Control		
IN FAILED ARRAY	Element		
REBUILD/REMAP	Set by the RQST REBUILD/REMAP on Array Device Control		
NEDUILD/NEIVIAF	Element		
R/R ABORT	Set by the RQST R/R ABORT on Array Device Control		
N/R ADON I	Element		
DO NOT REMOVE	Set by the DO NOT REMOVE on Array Device Control		
DO NOT REMOVE	Element		
READY TO INSERT	Set by the RQST INSERT on Array Device Control Element		
RMV	Set by the RQST REMOVE on Array Device Control Element		
IDENT	Set by the RQST IDENT on Array Device Control Element		
FAULT REQSTD	Set by the RQST FAULT on Array Device Control Element		
DEVICE OFF	Set by the DEVICE OFF on Array Device Control Element		

5. SES Element Control Functions

5.1. LED indicators (green and red) associated with an attached disk drive Array Device Slot control element

BYTE/BIT	7	6	5	4	3	2	1	0		
0		COMMON CONTROL								
	SELECT	PRDFAIL	DISABLE	RST SWAP		Reser	ved			
1	RQST	RQST RSVD	RQST HOT	RQST CONS	RQST IN	RQST IN FAILED	RQST REBULD/	RQST R/R		
	ок	DEVICE	SPARE	CHECK	CRIT ARRAY	ARRAY	REMAP	ABORT		
2	RQST	DO NOT	Reserved	RQST	RQST	RQST REMOVE	RQST IDENT	Reserved		
	ACTIVE	REMOVE	Reserved	MISSING	INSERT	RQST REMOVE	NQST IDENT	Reserved		
3	D	eserved	RQST	DEVICE OFF	ENABLE BYP	ENABLE BYP B	Pagany	od		
	n.	eserveu	FAULT	DEVICE OFF	Α	ENABLE BYP B	Reserved			

The default behavior for green LED is "LED is on when the disk is not busy, and off when the disk is executing a command". When the "RQST IDENT" bit is set, the green LED overwrites its default behavior with a slow blink while the red LED is off. The green LED is set "Activity" for not overwriting its default behavior.

Slot Control Bit	Green LED	Red LED
RQST OK	Activity	OFF
RQST RSVD DEVICE	Activity	OFF
RQST HOT SPARE	Activity	OFF
RQST CONS CHECK	Activity	Fast blink
RQST IN CRIT ARRAY	Activity	Slow blink
RQST IN FAILED ARRAY	Activity	Slow blink
RQST REBUILD/REMAP	Activity	Fast blink
RQST R/R ABORT	Activity	Slow blink
RQST ACTIVE	Activity	OFF
DO NOT REMOVE	Activity	OFF
RQST MISSING	ON	ON
RQST INSERT	Activity	Slow blink
RQST REMOVE	Activity	Slow blink
RQST IDENT	Slow blink	OFF
RQST FAULT	ON	ON
DEVICE OFF	OFF	OFF
PRDFAIL	Activity	Slow blink

5.2. How to turn on/off the power of a drive slot

Array Device Slot control element

BYTE/BIT	7	6	5	4	3	2	1	0	
0		COMMON CONTROL							
	SELECT	PRDFAIL	DISABLE	RST SWAP		Reser	ved		
1	RQST	RQST RSVD	RQST HOT	RQST CONS	RQST IN	RQST IN FAILED	RQST REBULD/	RQST R/R	
	OK	DEVICE	SPARE	CHECK	CRIT ARRAY	ARRAY	REMAP	ABORT	
2	RQST	DO NOT	Reserved	RQST	RQST	RQST REMOVE	RQST IDENT	Paganyad	
	ACTIVE	REMOVE	neserved	MISSING	INSERT	NGST NEMOVE	NQ31 IDEN1	Reserved	
3	D	eserved	RQST	DEVICE OFF	ENABLE BYP	ENABLE BYP B	Posony	bo	
	n.	zsei veu	FAULT	DEVICE OFF	Α	LIVABLE DIF D	Reserved		

The "DEVICE OFF" for a drive slot is defined in the bit4, byte3 of the "Array Device Slot control element" in the SES specification. Set the bit to turn off a slot power, and vice versa.

5.3. How to manually change fan speed for local or remote Cooling elements Cooling control element

BYTE/BIT	7	6	5	4	3	2	1	0
0		COMMON CONTROL						
	SELECT	PRDFAIL	DISABLE	RST SWAP	Reserved			
1	RQST IDENT			Re	Reserved			
2		Reserved						
3	Reserved	RQST FAIL	RQST ON	Reser	erved REQUESTED SPEED CO		O CODE	

The "RQST IDENT" for Cooling is defined in the bit7, byte1 of the "Cooling control element" in the SES specification. Set "RQST IDENT" bit to disable the smart fan function, and then change fan speed with one of the two methods below. Clear "RQST IDENT" bit to enable the smart fan function again. Please disable the smart fan function before changing fan speed.

(A) The "REQUESTED SPEED CODE" is defined in the bit2 ~ 0, byte3 of the "Cooling control element" in the SES specification. The fan speed for local or remote Cooling elements can be manually changed by setting the "REQUESTED SPEED CODE" bits. Only the Cooling element 0 (for local) and the Cooling element 4 (for remote) support this feature.

REQUESTED SPEED CODE

Code	Description
000b	Leave fan at current speed
001b	Set cooling mechanism to lowest speed
010b	Set cooling mechanism to second lowest speed
011b	Set cooling mechanism to third lowest speed
100b	Set cooling mechanism to intermediate speed
101b	Set cooling mechanism to third highest speed
110b	Set cooling mechanism to second highest speed
111b	Set cooling mechanism to highest speed

(B) Through the Byte1 of the "Vendor specific Expander PWM out" page, the fan speed for local or remote Cooling elements can be changed manually.

6. Online Firmware Update

6.1. Expander firmware and MFG update

- (1) Use the open source sg3_utils to perform firmware and MFG update via inband SAS. The sg3_utils is supported by Windows and Linux.
- (2) Use LSI xtools, "xflash" to reset the expander chip to activate the new firmware and MFG. via inband SAS.

6.2. PIC firmware update

- (1) Force local Bridge PIC to stay in the bootloader mode by sending the "String Out" page.
- (2) Use Microchip PIC32 Bootloader Application PIC32UBL to update firmware, and then run the new firmware. Microchip PIC32UBL is only supported by Windows. Users can develop PIC32 Bootloader Application for Linux based on Microchip PIC32UBL source.

7. Temperature sensor and cooling connector locations

	Bridge Board	
Cooling 2/3		Cooling 0/1
	Backplane Board	
Temp Sensor-0	Temp Sensor-1	Temp Sensor-2
	Drive Bay	
	24 Disk Drives	